

The Drift Chamber of the MEGII experiment

Giovanni Francesco Tassielli,

Gianluigi Chiarello and Marco Chiappini on behalf of MEG-II CDCH groups - INFN Lecce, Roma and Pisa 28 February 2020 INSTR 2020 - Novosibrisk







Overview

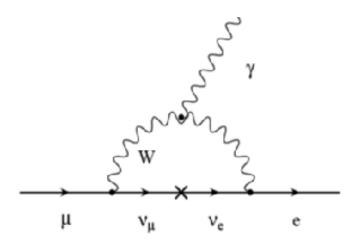
- Mu E Gamma search and MEG-II
- MEG II Cylindrical Drift CHamber (CDCH)
 - Novel approach for construction technique of high granularity and high transparency Drift Chambers
 - The wiring Robot and the wiring procedures
 - The assembly procedure
 - Front End electronics
 - Problems experienced during the construction
 - Expected performance
- Data taking runs
- Conclusions







Mu e gamma search



$$\mathcal{L}_{cLFV} = \frac{m_{\mu}}{(k+1)\Lambda^2} \mathcal{L}_{loop} + \frac{k}{(k+1)\Lambda^2} \mathcal{L}_{contact} + h.c.$$

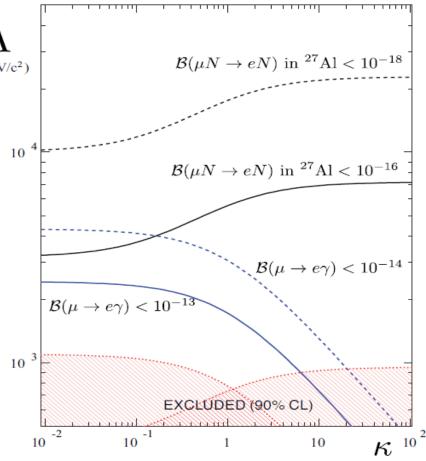
Mass scale inaccessible to direct search

(TeV/c2)

SM extension + v oscillations

but not experimentally observable: m_v small \rightarrow BR<10⁻⁵⁰ Beyond SM theories (SUSY-GUT) predict cLFV interactions rare but enhancement up to an observable level (BR($\mu^+ \rightarrow e^+ \gamma$) $\approx 10^{-(14-15)}$) In this context the MEG experiment represents the state of the art in the search for the CLFV $\mu^+ \rightarrow e^+ \gamma$ decay

Final results exploiting the full statistics collected during the 2009-2013 data taking period at Paul Scherrer Institute (PSI) BR($\mu^+ \rightarrow e^+ \gamma$) < 4.2·10⁻¹³ (90% C.L.) world best upper limit

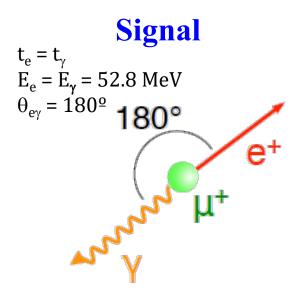


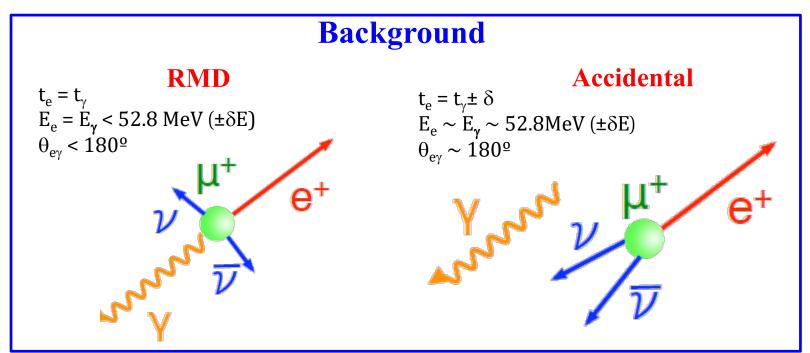






MEG event kinematic





- radiative decay $\mu \rightarrow e \nu \nu \gamma$ two neutrinos have low energy and γ and e emitted back-to-back with high energy
- "accidental": e and γ from different sources but with compatible kinematics to the $\mu \rightarrow e \gamma$ (e.g. e^+ from Michel decay, γ from RMD, e^+e^- annihilation...)

Accidental background is **dominant** and determined by **beam rate** and **resolutions**:

$$B_{acc} \propto R_{\mu}^2 \Delta E_e \Delta E_{\gamma}^2 \Delta \theta_{e\gamma}^2 \Delta t_{e\gamma}$$

 $B_{RMD} \approx 0.1 \cdot B_{acc}$



Radiative decay counter (RDC)





The MEG II Experiment

Target Sensitivity: 6·10⁻¹⁴ in 3 years of running

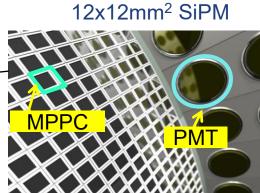
(pTC)

Muon stopping target

x2 resolution everywhere

Liquid xenon photon detector (LXe) COBRA superconducting magnet $7x10^7 \mu/s$ (x2.3)

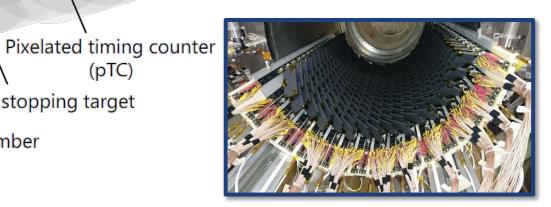
> Cylindrical drift chamber (CDCH)



Better uniformity w/ VUV-sensitive



LYSO crystals + plastic scintillators (Further reduction of radiative BG)





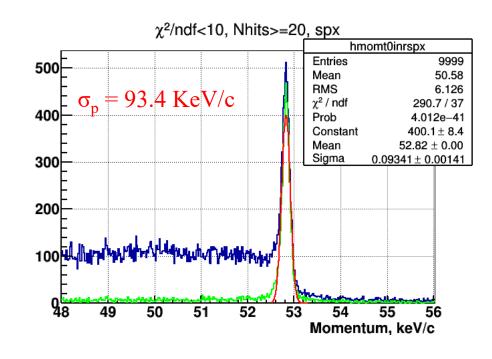




The MEG II Experiment

- The MEG sensitivity does not increase linearly with the amount of data taking anymore
 - Limited by the resolutions on the measurement of the kinematic variables of the two decay products
- MEG I DC did not perform as expected.
- Main problems were:
 - Few hits on the positron track (8-16)
 - Active volume of the detector only partly instrumented
 - Large track extrapolation to Timing counter

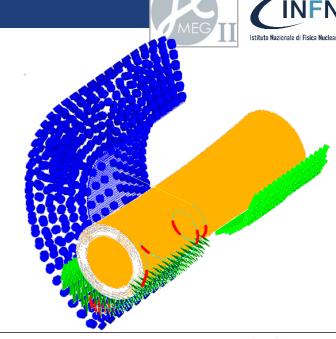
Variable	Design (MEG)	Obtained (MEG)	Foreseen (MEG II)		
ΔE_e (keV)	200	380	~100		
$\Delta heta_e$, $\Delta arphi_e$ (mrad)	5, 5	9, 9	6, 5.5		
Efficiency _e (%)	90	40	>65		
ΔE_{γ} (keV)	1.2	1.7	1.0		
$\Delta Position_{\gamma}$ (mm)	4	5	< 3		
$\Delta t_{e\gamma}$ (ps)	65	120	85		
Efficiency _γ (%)	> 40	60	70		





MEG II Drift chamber: design

- Single volume, small cells, full stereo cylindrical drift chamber;
- A large field to sense wires ratio (5 : 1) allows for thinner field wires, thus reducing the wire contribution to multiple scattering and the total wire tension on the end-plates.
- Light gas mixture (90% He 10% iC₄H₁₀)
- Positron efficiency > 65% (better coupling with TC, very short extrapolation needed);
- High rate capability (at the centre 30kHz/cm²), drift cell size of ~6mm required
- Single hit resolution (~110 μ m) and gas aging effects verified on prototypes and test stations (at $7x10^7\mu$ /s and 10^5 gain, $\Delta g/\Delta V \sim 4\%/V$ over 3 years equivalent).
- Cluster Timing readout capabilities (high bandwidth, high sampling rate) to further reduce spatial resolution



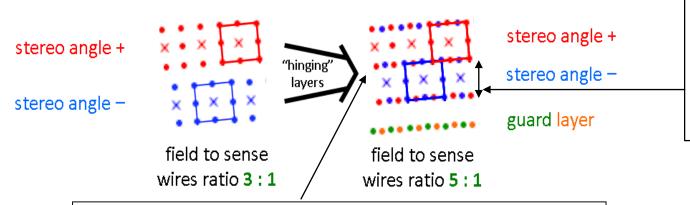
tic) C	10 -:		
tic) C	1 20	1	
	1.20	0.28	
C	0.41		
n Al) 📗 C	0.33	0.78	
С	0.04		
n) C).21	0.21	
C	0.06	0.59	
10) 0).53		
· · · · · · · · · · · · · · · · · · ·			
	1	58	
	n) (10) (n) 0.21 0.06 10) 0.53	







MEG II Drift chamber: design



Full stereo cylindrical DC with large stereo angles (102÷147 mrad)
Small square cells
(5.8÷7.8 mm at z=0, 6.7÷9.0 at z=±L/2)
(~ 12 wires/cm²)

The wire net created by the combination of + and – orientation generates a more uniform equipotential plane

Active length L	1932	mm
N. of layers	9	
N. of stereo sectors	12	
N. of cells per layer	192	
N. of cells per sector	16	
Cell size (at z=0)	5.8 ÷ 7.8	mm
Twist angle	±60°	
Stereo angle	102 ÷ 147	mrad
Stereo drop	35.7 ÷ 51.4	mm

sense wires: 20 μ m diameter W(Au) => 1728 wires field wires: 40 μ m diameter Al(Ag) => 7680 wires

f. and g. wires: $50 \mu m \text{ diameter Al(Ag)} => 2496 \text{ wires}$

11904 wires in total

High wire densities, anyway, require complex and time consuming assembly procedures and need novel approaches to a feed-through-less wiring



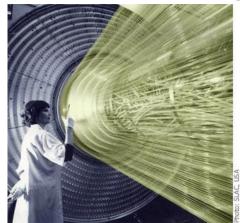




MEG II Drift chamber: The novel approch

- Separate the end-plate function: mechanical support for the wires and gas sealer;
- Find a feed-trough-less wiring procedure.

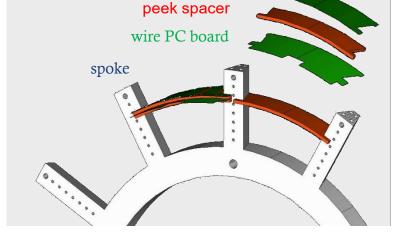
(~ 12 wires/cm²) can't be built with feedthrough





The solution found for MEG II:

- end-plates numerically machined from solid Aluminum (mechanical support only);
- Field, Sense and Guard wires placed azimuthally by Wiring Robot with better than one wire diameter accuracy;
- wire PC board layers (green) radially spaced by numerically machined peek spacers (red) (accuracy < 20 μm);
- wire tension defined by homogeneous winding and wire elongation ($\Delta L = 100\mu m$ corresponds to ≈ 0.5 g);
- Drift Chamber assembly done on a 3D digital measuring table;
- build up of layers continuously checked and corrected during assembly
- End-plate gas sealing will be done with glue.



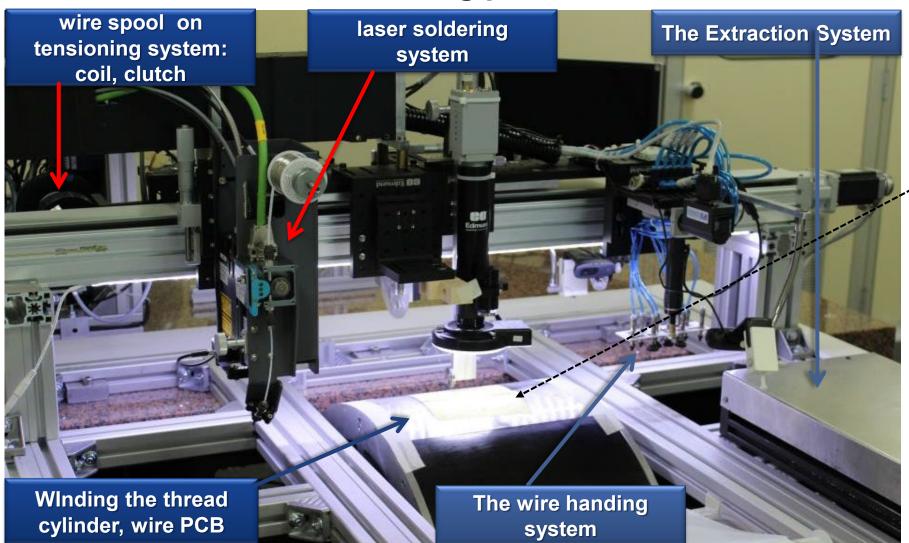
wire PC board



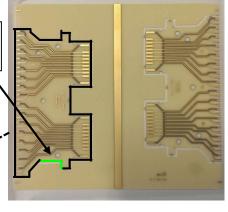




MEG II Drift chamber: Wiring procedure



reference edge for alignment



The main tasks of the wiring robot are:

- the wiring of a multiwire layer made of 32 parallel wires;
- settable wire tension (±0.05g);
- 20µm of accuracy on wire position;
- anchor the wires using a contact-less technique



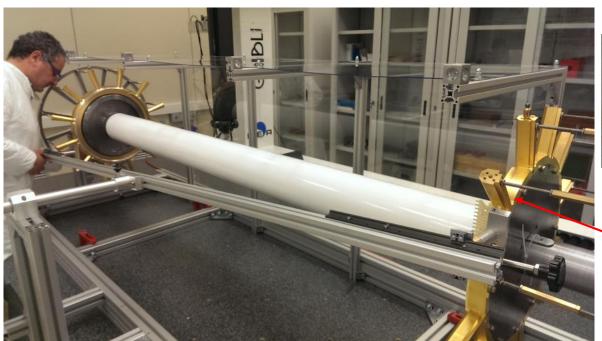




MEG II Drift chamber: Assembling

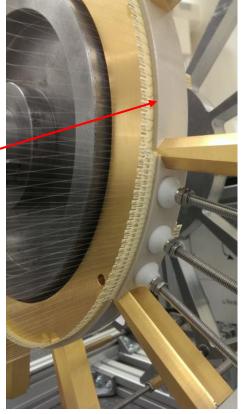
Procedure:

- The mounting arm (with the multi-wire layer) is then placed next to the end plates for the engagement procedure
- The mounting arm is fixed to a support structure to prevent damaging the wires
- This structure transfers the multi-layer wire on the end plates between two spokes
- Spacers, to separate the successive layer, are pressed and glued in position





Spoke used as reference for the alignment of the pcb









MEG II Drift chamber: Assembed

Procedure:

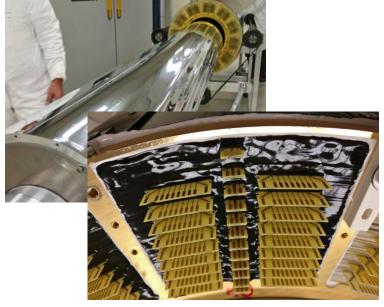
 After assembling all the layers, the DC is closed with 2 mmthick carbon fiber shell for structural function and gas tightness.

 DC was rotated 90 degrees to seal the end plate (wire-pcb and spacer);

- The inner mylar aluminized foil (20 μm) was mounted
- Fine geometry tuning by adjusting the positions of each individual spoke by acting on the 12 turnbuckles per side
- Endplates planarity and parallelism at a level better than 100 µm thanks to the CMM







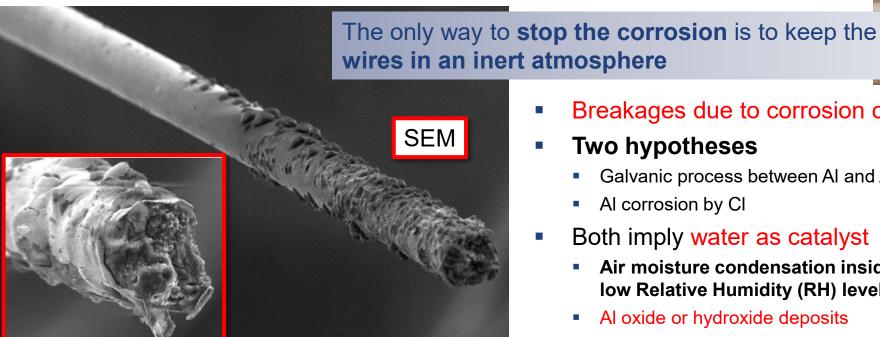






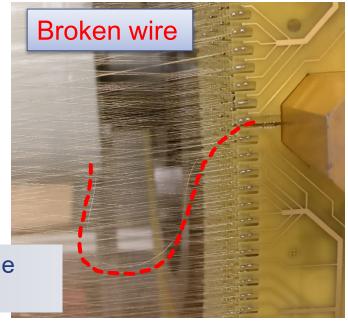
MEG II Drift chamber: Wire breakages

- During assembly at Pisa and the final lengthening operations at PSI we experienced the breakages of some Al wires in the chamber
 - Mainly the 40 µm cathodes were affected
 - A few 50 µm cathodes and guards
- 65 broken wires in total during CDCH life
- Consequent delay in construction and commissioning



- Breakages due to corrosion of the Al wire core
- Two hypotheses
 - Galvanic process between Al and Ag coating
 - Al corrosion by Cl
- Both imply water as catalyst
 - Air moisture condensation inside cracks in the Ag coating even at Iow Relative Humidity (RH) levels <40%
 - Al oxide or hydroxide deposits

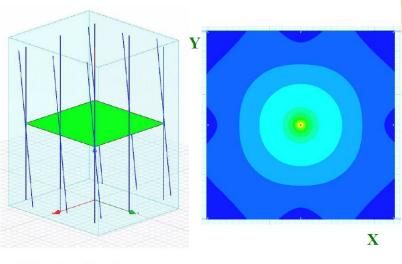


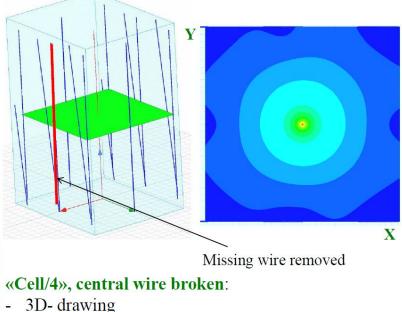


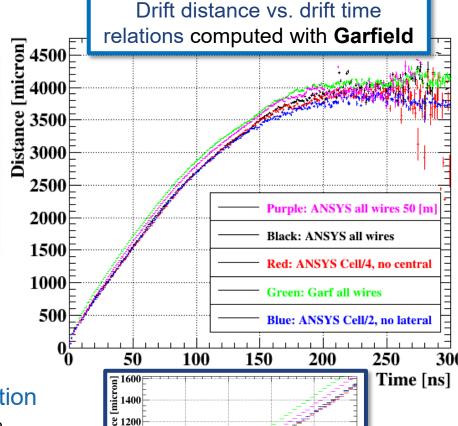




MEG II Drift chamber: Missing wires effect







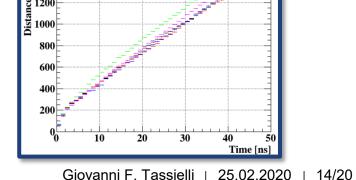
«Ideal», all wires:

- 3D-drawing
- Potential
 - Study the effect of a missing cathode on isochrones → e⁺ reconstruction

Potential

- Used **Garfield** and **ANSYS** to simulate the electric field in a 6x6 mm² representative drift cell
 - Single-hit resolution σ hit < 120 μ m
 - Difference between different curves → ≈ 10 µm
- Missing wire effect negligible (<10%)









MEG II Drift chamber: Electronics

Requirements:

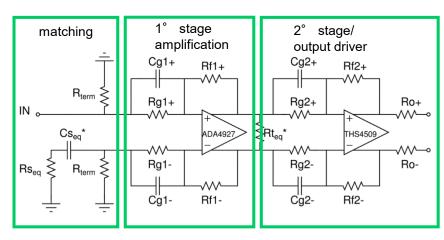
- High bandwidth >700 MHz
- Good gain: ~10
- High density < 7mm channel width
- Fully differential
- Low power consumption (50mW)

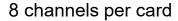
analog gain and Bandwidth after 5m cable: 19db and ~ 900MHz

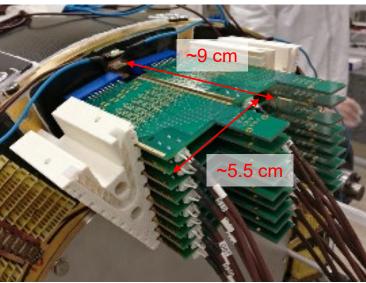
DAQ based on Waveform digitizer (DRS4), called WaveDREAM, developed by PSI:

- 1.2 2 GS/s
- 1024 bins

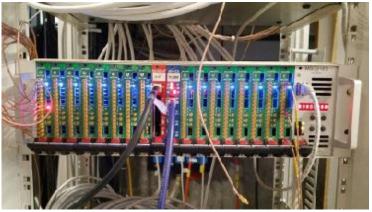
(not available with full differential input for the commissioning, we had to convert back the signal to single-end) see poster 87: The Front End Electronics for the Drift Chamber readout in MEG experiment upgrade

















MEG II Drift chamber: HV working point

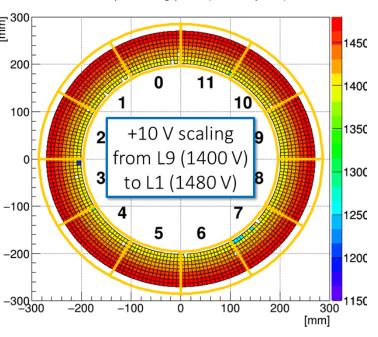
- Garfield simulations on single electron gain
- Gas mixture He:Isobutane 90:10 and P = 970 mbar (typical at PSI)
- Working point \rightarrow HV for gain $G = 5.10^5$ (1400-1480V)

We tested electrostatic stability up to working point + 100V (green = goal reached)

Layer	50	51	52	53	54	55	56	57	58	59	510	511
9 (1500 V)	1500	1500	1500	1500	1500	1430	1500	1500	1500	1500	1500	1500
8 (1510 V)	1510	1510	1510	1500	1510	1510	1510	1510	1510	1510	1510	1510
7 (1520 V)	1520	1520	1520	1520	1520	1520	1520	1520	1520	1520	1520	1520
6 (1530 V)	1530	1530	1530	1530	1530	1530	1530	1530	1530	1530	1530	1530
5 (1540 V)	1540	1540	1540	1540	1540	1540	1540	1540	1540	1540	1540	1540
4 (1550 V)	1550	1550	1550	1550	1550	1550	1550	1550	1550	1550	1550	1550
3 (1560 V)	1560	1560	1560	1560	1560	1560	1560	1560	1560	1560	1560	1560
2 (1570 V)	1570	1570	1570	1570	1570	1570	1570	1570	1570	1570	1570	1570
1 (1580 V)	1580	1580	1580	1580	1580	1580	1580	1580	1580	1580	1580	1580

see poster 10: Commissioning of the MEG II tracker system

HV map working point (US endplate)



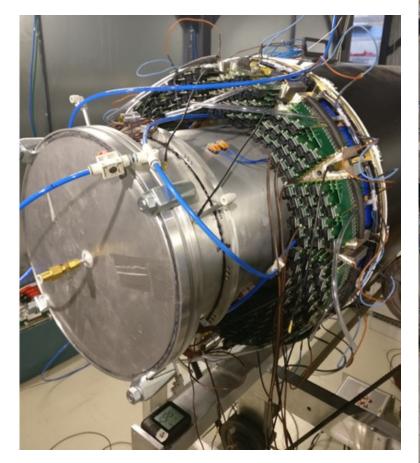
"dead" channels of 1.3% negligible in e+ reconstruction



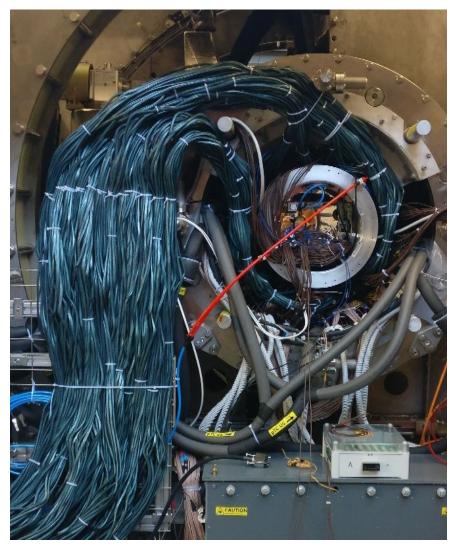




MEG II Drift chamber: In the experiment











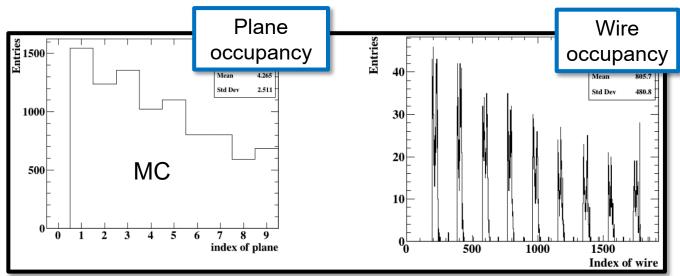


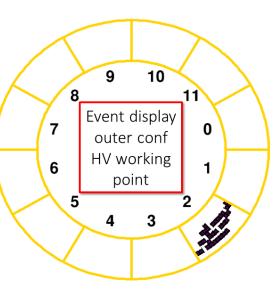
MEG II Drift chamber: data taking

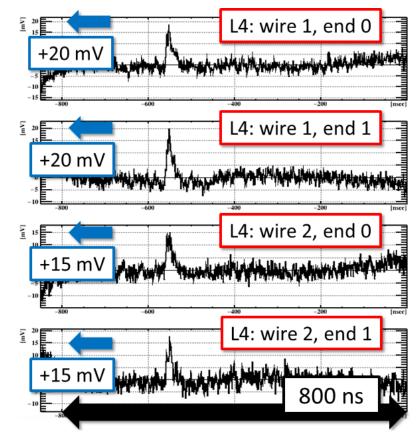
Only 192 DAQ channels available for 2018 and 2019 runs

HV scan performed with:

- Cosmic Rays (CR) for gain calibration purposes in a clean environment
- Michel e⁺ with µ⁺ beam at different intensities (pTC trigger)







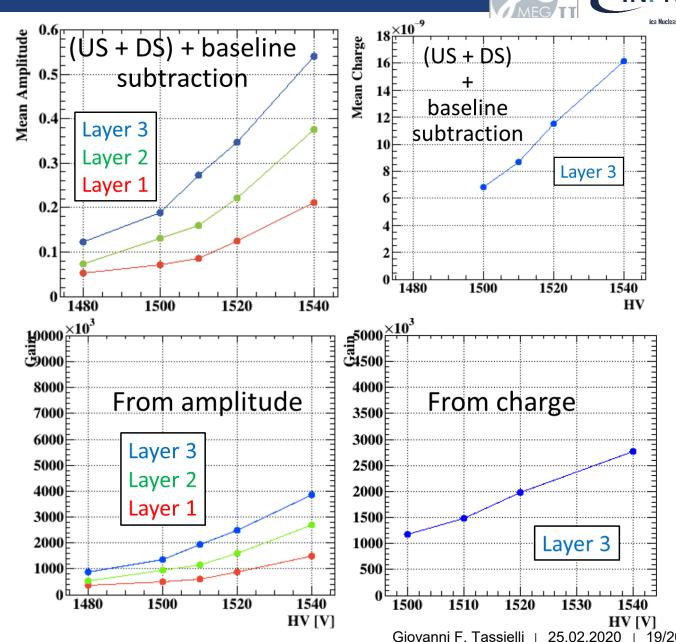






MEG II Drift chamber: data taking

- The mean amplitude and charge from cosmic ray data are converted into the effective gas gain G
- By means of simulations of the ionization clusters and the response of the FE amplification stage
- Calibrated gain curves in agreement with simulations









CONCLUSION

- The upgrade of the positron tracker of the MEG II experiment consists in a full stereo, with high granularity and high transparency ($\sim 1.6 \cdot 10^{-3} \text{ X}_0$) Drift Chamber
- It is a crucial detector to improve the angular and momentum resolutions of the e⁺ kinematic variables, thus minimizing the background sources
- The novel design concept and the modular construction have been described
- CDCH mechanics proved to be stable and adequate to sustain a MEG II run
- We experienced some ~60 (over ~12000) broken wires, all of them due to a corrosion issue, no additional breaks after the closing of the chamber in the right atmosphere
- During the commissioning activities at PSI the working configuration was reached and CDCH was fully integrated into the MEG II experimental apparatus for the data taking
- The commissioning is still on going to fix the unexpected problems about the stability of the chamber
- We expect to reinstall the chamber during the 2020 for a final commissioning and starting the data tacking







backup





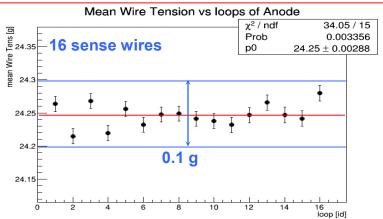


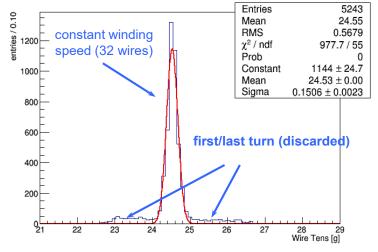
MEG II Drift chamber: Wiring procedure

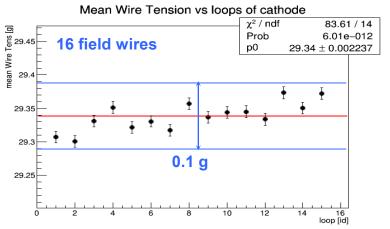
The wire mechanical tension is delivered by an electromagnetic clutch and its on-line monitored by a high precision strain gauge, a real-time feedback system correct any variation.



wire tension mean value is stable at the level of 0.05 g







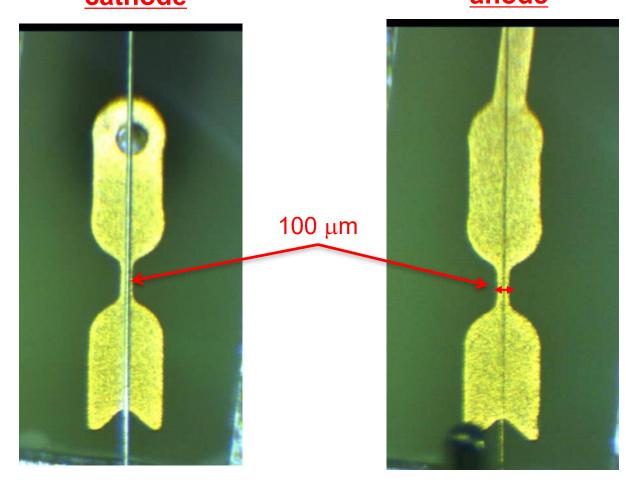




MEG II Drift chamber: Wiring procedure

All wires position is optically monitored, a precision on the relative position is ~20 µm

20µm of accuracy on wire position cathode anode





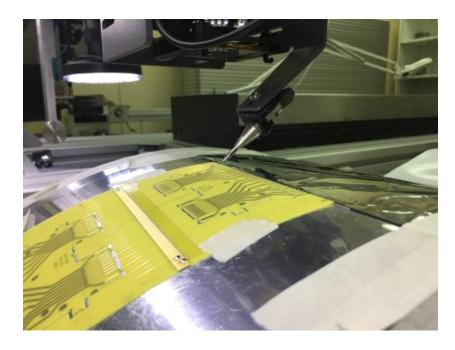


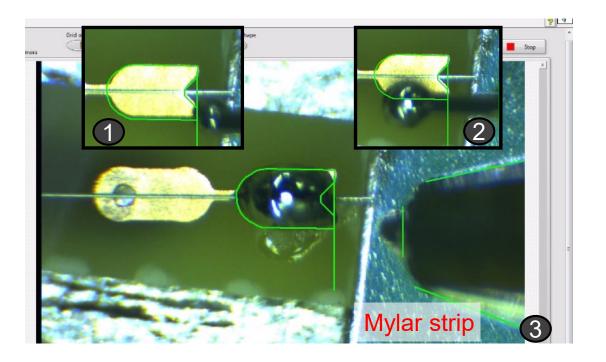


MEG II Drift chamber: Wiring procedure

Soldering:

- The soldering phase is accomplished by an LASCON 501 IR laser soldering System.
- The laser system is controlled by the NI Compact RIO and is synchronized with the positioning system.
- The wires, during the soldering phase, are covered by a Mylar foil







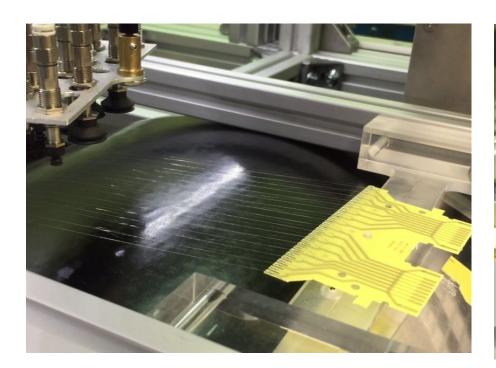


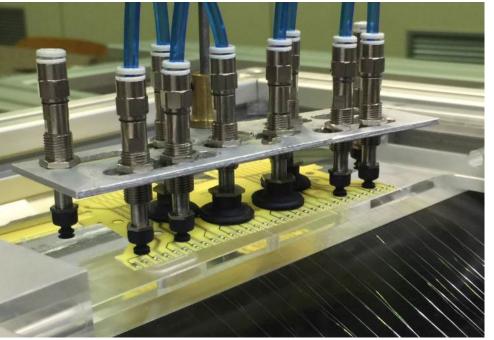


MEG II Drift chamber: Wiring procedure

Extraction:

- The wound layer of soldered wires must be unrolled from the winding drum and de-tensioned for storage and transport to the assembly station.
- The wire PCBs are lifted off from the cylinder with a linear actuator connected to a set of vacuum operated suction cups.









14.72 / 3

0.002073

-8.91e+005 ± 338.7

464.8 ± 0.1761

Prob

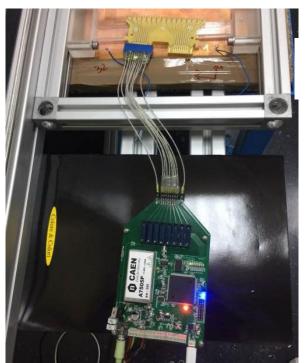
2000

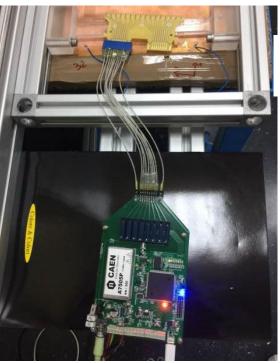


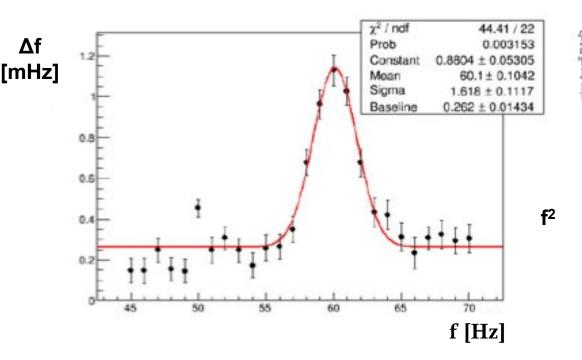
MEG II Drift chamber: Wiring procedure

Check mechanical tension:

- The system induces oscillation in a wire by means of a pulsed HV signal and measures the frequency of the first harmonic resonance of wire by measuring the variation of its capacitance
- The system shows the ability to resolve each frequencies of two field wires in a system made by two field wires and one sense wire placed in the middle









L [mm]

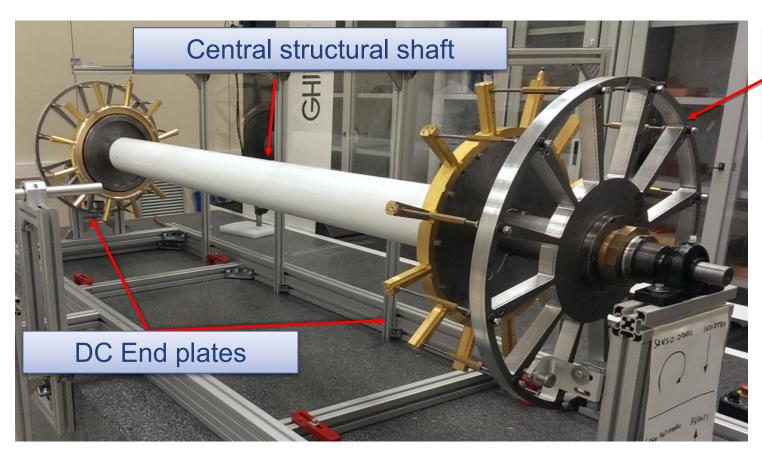




MEG II Drift chamber: Assembling

Structure:

 During the assembly phase, the endplates are placed at a shorter distance than nominal to avoid stressing the wires



Wire tension compensating wheels



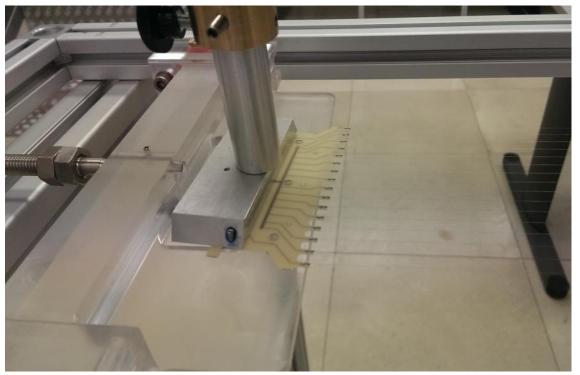




MEG II Drift chamber: Assembling

Procedure:

- The mounting procedure is performed with an adjustable arm and a flipping arm which is used to flip layers;
- The wire-PCBs, fixed on the transport frame, are anchored to the mounting arm with a clip and released from the frame.







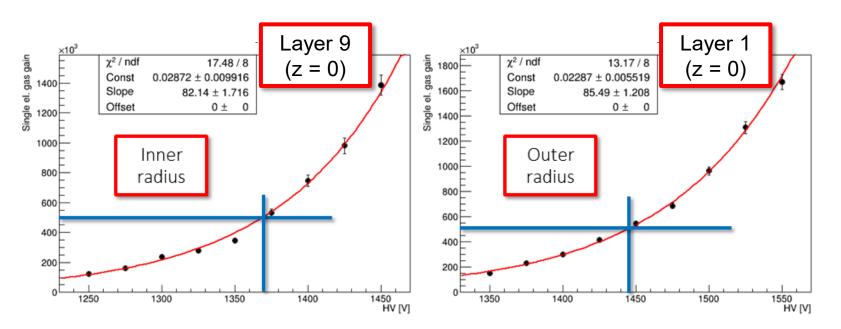




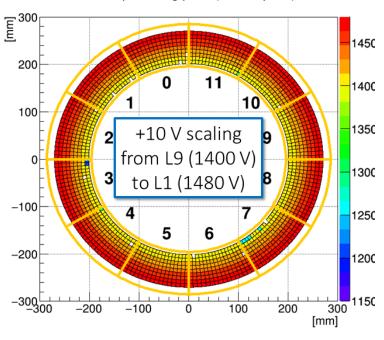


MEG II Drift chamber: HV working point

- Garfield simulations on single electron gain
- Gas mixture He:Isobutane 90:10 and P = 970 mbar (typical at PSI)
- Working point \rightarrow HV for gain $G = 5.10^5$



HV map working point (US endplate)



"dead" channels of 1.3% negligible in e+ reconstruction

L1	L2	L3	L4	L5	L6	L7	L8	L9
1480 V	1470 V	1460 V	1450 V	1440 V	1430 V	1420 V	1410 V	1400 V

